WiFi/Bluetooth Ceramic Chip Antenna
Model: AA055A
TELA chip antenna
Product Number: H2U34W1H1Z0400

REFERENCE SPECIFICATION
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1 Introduction

Unictron’s AA055A chip antenna is designed for 2.4 GHz applications, covering frequencies 2400 - 2500 MHz. Fabricated with proprietary design and processes, AA055A shows excellent performance and is fully compatible with SMT processes which can decrease the assembly cost and improve the device’s quality and consistency.

Features

* Stable and reliable in performances
* Low temperature coefficient of frequency
* Low profile, compact size
* RoHS compliance
* SMT processes compatible

Applications

* ISM 2.4 GHz applications
* ZigBee/BLE applications
* Bluetooth earphone systems
* Hand-held devices when WiFi / Bluetooth functions are needed, e.g., Smart phones
* IEEE802.11 b/g/n
* Wireless PCMCIA cards or USB dongles
## 2 Electrical Characteristics

### 2.1 Table with electrical properties:

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Specifications</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Outline Dimensions</td>
<td>3.2x1.6x0.5</td>
<td>mm</td>
</tr>
<tr>
<td>Ground Plane</td>
<td>80x40</td>
<td>mm</td>
</tr>
<tr>
<td>Working Frequency</td>
<td>2400~2500</td>
<td>MHz</td>
</tr>
<tr>
<td>VSWR (@Center Frequency)*</td>
<td>2 Max.</td>
<td></td>
</tr>
<tr>
<td>Characteristic Impedance</td>
<td>50</td>
<td>Ω</td>
</tr>
<tr>
<td>Polarization</td>
<td>Linear Polarization</td>
<td></td>
</tr>
<tr>
<td>Peak Gain (@2442MHz)</td>
<td>2.5 (typical)</td>
<td>dBi</td>
</tr>
<tr>
<td>Efficiency</td>
<td>84 (typical)</td>
<td>%</td>
</tr>
</tbody>
</table>

*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board.
2.2 Return Loss ($S_{11}$)

![Graph of Return Loss](image1)

2.3 VSWR ($S_{11}$)

![Graph of VSWR](image2)
2.4 Efficiency Table

<table>
<thead>
<tr>
<th>Frequency (MHz)</th>
<th>2400</th>
<th>2412</th>
<th>2417</th>
<th>2422</th>
<th>2427</th>
<th>2437</th>
<th>2442</th>
<th>2447</th>
<th>2452</th>
<th>2457</th>
<th>2462</th>
<th>2467</th>
<th>2472</th>
<th>2484</th>
<th>2500</th>
</tr>
</thead>
<tbody>
<tr>
<td>Efficiency (dB)</td>
<td>-1.4</td>
<td>-1.0</td>
<td>-0.9</td>
<td>-0.8</td>
<td>-0.8</td>
<td>-0.7</td>
<td>-0.7</td>
<td>-0.8</td>
<td>-0.8</td>
<td>-0.9</td>
<td>-0.9</td>
<td>-1.0</td>
<td>-1.2</td>
<td>-1.4</td>
<td></td>
</tr>
<tr>
<td>Efficiency (%)</td>
<td>72.8</td>
<td>78.7</td>
<td>80.4</td>
<td>82.3</td>
<td>83.0</td>
<td>83.9</td>
<td>84.4</td>
<td>84.5</td>
<td>84.1</td>
<td>84.0</td>
<td>83.2</td>
<td>82.0</td>
<td>80.5</td>
<td>78.6</td>
<td>75.4</td>
</tr>
<tr>
<td>Peak Gain (dBi)</td>
<td>1.5</td>
<td>1.8</td>
<td>1.9</td>
<td>2.1</td>
<td>2.3</td>
<td>2.3</td>
<td>2.4</td>
<td>2.5</td>
<td>2.5</td>
<td>2.4</td>
<td>2.4</td>
<td>2.2</td>
<td>2.1</td>
<td>1.9</td>
<td>1.8</td>
</tr>
</tbody>
</table>

2.5 Efficiency vs. Frequency
2.6 Radiation Pattern (with 80x40mm² Evaluation Board)

3D Gain Pattern @ 2442 MHz (unit: dBi)
3 Layout

3.1 Antenna Dimensions

PIN Definitions

<table>
<thead>
<tr>
<th>PIN</th>
<th>PIN1</th>
<th>PIN2</th>
</tr>
</thead>
<tbody>
<tr>
<td>Soldering pad</td>
<td>Signal</td>
<td>Tuning/Ground</td>
</tr>
</tbody>
</table>

NOTE:
1. All materials are RoHS compliant
2. “Ⓐ - Ⓝ” Critical dimensions
3. “ ( ) “ Reference dimensions
3.2 Evaluation Board with Antenna

Unit: mm
3.3 Solder Land Pattern

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer’s installation conditions.

Transmission line with 50 Ohm impedance characteristics.
4 Frequency tuning

Chip antenna tuning scenario

With the following recommended values of matching and tuning components, the center frequencies will be about 2442 MHz at our standard 80x40 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.

### System Matching Circuit Component

<table>
<thead>
<tr>
<th>Location</th>
<th>Description</th>
<th>Vendor</th>
<th>Tolerance</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>1.2 pF (0402)</td>
<td>DARFON</td>
<td>±0.1 pF</td>
</tr>
<tr>
<td>2</td>
<td>3.3nH (0402)</td>
<td>DARFON</td>
<td>±0.1 nH</td>
</tr>
<tr>
<td>3</td>
<td>N/A</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>4</td>
<td>Fine tuning element</td>
<td>1.5 pF (0402)</td>
<td>DARFON</td>
</tr>
</tbody>
</table>
4.1 Reference for frequency tuning element

4.7pF, 2.11GHz
1.8pF, 2.31GHz
1pF, 2.52GHz
0.8pF, 2.66GHz
0.6pF, 2.80GHz
5 Packing

1. Quantity/Reel: 5000 pcs/Reel
2. Plastic tape:

   a) Tape drawing:

   b) Tape dimensions (unit: mm)

<table>
<thead>
<tr>
<th>Feature</th>
<th>Specifications</th>
<th>Tolerances</th>
</tr>
</thead>
<tbody>
<tr>
<td>W</td>
<td>12.00</td>
<td>±0.30</td>
</tr>
<tr>
<td>P</td>
<td>4.00</td>
<td>±0.10</td>
</tr>
<tr>
<td>E</td>
<td>1.75</td>
<td>±0.10</td>
</tr>
<tr>
<td>F</td>
<td>5.50</td>
<td>±0.10</td>
</tr>
<tr>
<td>P2</td>
<td>2.00</td>
<td>±0.10</td>
</tr>
<tr>
<td>D</td>
<td>1.50</td>
<td>+0.10 -0.00</td>
</tr>
<tr>
<td>Po</td>
<td>4.00</td>
<td>±0.10</td>
</tr>
<tr>
<td>10Po</td>
<td>40.00</td>
<td>±0.20</td>
</tr>
</tbody>
</table>

   c) Reel Drawing:
d) Drawing of small size carton in developed view

![Small size carton drawing](image1)

e) Drawing of middle size carton in developed view

![Middle size carton drawing](image2)
f) Drawing of large size carton in developed view

g) Picture of the label

h) Reel with the label
5.1 Packing process

1 reel includes max 5000 pieces chip antennas

1 small size carton includes max 2 reels

1 middle size carton includes max 5pcs of small cartons

1 large size carton includes max 2 pcs of middle size cartons
6 Notes

6.1 Typical Soldering Profile for Lead-free Process

![Soldering Profile Diagram]

- Pre-heating
- Temperature (°C)
- Time (s)
- 260°
- 217°
- 150-200°
- 60-180s
- 20-40s
- 60-150s
6.2 Operating and storage conditions:

**Operating:**
- Maximum Input Power: 2W
- Operating Temperature: -40°C to 85°C

**Storage:**
- Storage Temperature: -5°C to 40°C
- Relative Humidity: 20% to 70%
- Shelf Life: 1 year

6.3 Installation guide:

Request Unictron’s application notes “General guidelines for the installation of Unictron’s chip antennas” for further information at e-sales@unictron.com.

6.4 Reminders for users of Unictron’s AA055A ceramic chip antennas

6.4.1. This chip antenna is made of ceramic materials which are relatively more rigid and brittle compared to printed circuit board materials. Bending of circuit board at the locations where chip antenna is mounted may cause the cracking of solder joints or antenna itself.

6.4.2. Punching/cutting of the break-off tab of PCB panel may cause severe bending of the circuit board which may result in cracking of solder joints or chip antenna itself. Therefore break-off tab shall be located away from the installation site of chip antenna.

6.4.3. Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.
Presented data were measured on reference PCB (ground) as shown in this specification. When the antenna placement or size of the PCB is changed, antenna performance and values of matching components may differ from data shown here.

Information presented in this Reference Specification is believed to be correct as of the date of publishing. Unictron Technologies Corporation reserves the rights to change the Reference Specification without notice due to technical improvements, etc. Please consult with Unictron’s engineering team about the latest information before using this product. Per request, we may provide advice and assistance in implementing this antenna to a customer’s device by simulation or real measurement of the interested device in our testing facilities.

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